

# Investigation of grainboundaries in BaSi2epitaxialfilms on Si(1 1 1) substrates using transmissionelectronmicroscopy and electron-beam-induced current technique

著者別名	都甲 薫, 末益 崇
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- 1 Investigation of grain boundaries in BaSi<sub>2</sub> epitaxial films on Si(111)
- 2 substrates using transmission electron microscopy and
- **3** electron-beam-induced current technique
- 5 Masakazu Baba<sup>a</sup>, Katsuaki Toh<sup>a</sup>, Kaoru Toko<sup>a</sup>, Noriyuki Saito<sup>b</sup>, Noriko Yoshizawa<sup>b</sup>, Karolin
- 6 Jiptner<sup>c</sup>, Takashi Sekiguchi<sup>c</sup>, Kosuke Hara<sup>d</sup>, Noritaka Usami<sup>d,e</sup> and Takashi Suemasu<sup>a,e</sup>
- 8 <sup>a</sup>Institute of Applied Physics, University of Tsukuba, 1-1-1 Tennohdai, Tsukuba, Ibaraki
- 9 *305-8573*, *Japan*

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- 10 bElectron Microscope Facility, IBEC Innovation Platform, AIST, 16-1 Onogawa, Tsukuba
- 11 305-8569, Japan
- 12 <sup>c</sup>Advanced Electronic Materials Center, National Institute for Materials Science, Tsukuba,
- 13 Ibaraki 305-0044, Japan
- <sup>d</sup>Institute for Materials Research, Tohoku University, Sendai 980-8577, Japan
- <sup>e</sup>Japan Science and Technology Agency, CREST, Chiyoda-ku, Tokyo 102-0075, Japan

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a-Axis-oriented undoped n-BaSi<sub>2</sub> epitaxial films were grown on Si(111) substrates by molecular beam epitaxy, and the crystalline quality and grain boundaries were investigated by means of reflection high-energy electron diffraction, X-ray diffraction, and transmission electron microscopy (TEM). The grain size of the BaSi<sub>2</sub> films was estimated to be approximately 0.1-0.3 μm, and straight grain boundaries (GBs) were observed in the plan-view TEM images. Dark-field TEM images under two-beam diffraction conditions showed that these GBs consist mostly of BaSi<sub>2</sub> {011} planes. The diffusion length of minority carriers in n-BaSi<sub>2</sub> was found to be approximately 10 μm by an electron-beam-induced current technique.

## 1. Introduction

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Solar cells have recently been receiving considerable interest as a next-generation energy source to replace conventional sources such as oil and coal. Approximately 90% of solar cells are made from silicon owing to its abundance in the earth's crust, its well-known semiconducting properties and established handling technologies. The production of Si solar cells has been increasing year over year, and this trend is anticipated to continue in the future. However, it is difficult to realize high-efficiency thin-film solar cells using crystalline Si because the absorption coefficient is as small as approximately 10<sup>3</sup> cm<sup>-1</sup> at 1.5 eV and the band gap is 1.1 eV. These properties are not suitable for high-efficiency thin-film solar cells [1]. Therefore, other novel Si-based materials are of great interest for solar cells. We have specifically targeted realizing pn junction solar cells using semiconducting barium disilicide (BaSi<sub>2</sub>). Composed of the abundant Ba and Si, BaSi<sub>2</sub> has a very large absorption coefficient of  $3\times10^4$  cm<sup>-1</sup> at 1.5 eV, and a band gap of 1.3 eV, matching the solar spectrum [2-4]. Thus, BaSi<sub>2</sub> is considered to be an alternative new material to Si. Recent achievements of large photoresponsivity of BaSi<sub>2</sub> epitaxial layers formed on Si(111) substrates and polycrystalline BaSi<sub>2</sub> layers on SiO<sub>2</sub> substrates have spurred interest in this material [5-7]. Orthorhombic BaSi<sub>2</sub> is stable under ambient conditions and room temperature (RT), with lattice constants of a=0.891, b=0.672, and c=1.153 nm [8-10]. This material can be grown epitaxially on a Si(111) substrate with the orientation alignment of BaSi<sub>2</sub>(100)//Si(111), with a small lattice mismatch of 1.0% for BaSi<sub>2</sub>[010]//Si[112] and 0.1% for BaSi<sub>2</sub>[001]//Si[110] [11]. The grain size of BaSi<sub>2</sub> can be as small as approximately 0.1 µm [12], due to three epitaxial variants rotating around each other by 120° with respect to the surface normal [13,14]. Many grain boundaries (GBs) and other defects in a film typically deteriorate optical and electrical properties of the film. Thus, it is very important to investigate the GBs character in BaSi<sub>2</sub>. In the case of polycrystalline Si, GBs enhance carrier recombination due to their high defect densities [15], however this recombination activity depends significantly on the GB character due to the difference in the ability of gettering impurities. For example, low- $\Sigma$  GBs such as  $\Sigma$ 3 do not act as defect centers of minority carriers [16]. On the other hand, it is thought that recombination of carriers is suppressed by the local built-in potential at the GBs in the case of GBs in Cu(InGa)Se<sub>2</sub> [17]. However, there have been no reports thus far on GBs in BaSi<sub>2</sub> epitaxial films. The diffusion length of minority carriers, a key parameter determining the performance of solar cells, has yet to be evaluated in BaSi<sub>2</sub>. The electron-beam-induced current (EBIC) technique is considered to be a powerful method for investigating the electrical properties of various semiconductor materials [18].

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In this study, we grew a-axis-oriented BaSi<sub>2</sub> epitaxial films on Si(111) substrates by molecular beam epitaxy (MBE) and examined the GBs by transmission electron microscopy (TEM). It was found, from plan-view TEM images and selected-area electron diffraction (SAED) patterns, that the GBs in these BaSi<sub>2</sub> epitaxial films are composed mostly of

BaSi<sub>2</sub>{011} planes. We also evaluated the minority-carrier (holes) diffusion length in n-type BaSi<sub>2</sub> epitaxial layers using the EBIC technique.

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# 2. Experimental procedures

A two-stage growth method was adopted, which included reactive deposition epitaxy (RDE; Ba deposition on hot Si) and molecular beam epitaxy (MBE; co-deposition of Ba and Si) to form thick BaSi2 films [10]. The RDE process was carried out for deposition of a template layer as a BaSi<sub>2</sub> precursor prior to the subsequent MBE process [13,14]. The same growth method was successfully utilized for the epitaxial growth of semiconducting β-FeSi<sub>2</sub> films on both Si(001) and Si(111) substrates [19,20]. An ultrahigh vacuum (UHV) chamber equipped with a Knudsen cell for Ba and an electron beam gun for Si was employed. Before the growth, the n-Si substrates ( $\rho$ = 0.1  $\Omega$ ·cm) were prepared by subjecting them to the following treatment. The substrates were washed using RCA clean steps, which removed organic and metallic contaminants. The substrates were then annealed at 830 °C for 30 min in the UHV (1  $\times$  10<sup>-6</sup> Pa) chamber to remove the protective SiO<sub>2</sub> layers. After annealing, a 7×7 streaky reflection high-energy electron diffraction (RHEED) pattern was observed, indicating a clean Si surface.

We fabricated 300-nm-thick undoped n-BaSi<sub>2</sub> films by RDE at 550 °C for 5 min, followed by MBE at 600 °C for 120 min. Undoped BaSi<sub>2</sub> shows n-type conductivity with

electron concentrations of approximately  $10^{16}$  cm<sup>-3</sup> [2]. The crystalline quality of the films was evaluated using RHEED and  $\theta$ -2 $\theta$  X-ray diffraction (XRD) measurements. In order to investigate the grain size of BaSi<sub>2</sub> and GBs, plan-view TEM samples prepared by mechanical polishing and ion milling were observed using TOPCON EM-002B operated at 120 kV. For EBIC measurements, Al/n-BaSi<sub>2</sub> Schottky diode was formed. Front-side Schottky contacts were formed with Al on the BaSi<sub>2</sub> surface via wire bonding, and the back-side ohmic contact was made with Al by sputtering. EBIC observations were carried out in the edge-scan configuration with a Hitachi S4300 field-emission scanning electron microscope (SEM) in the EBIC mode at RT [16]. The acceleration voltage of the electron beam,  $V_{ac}$ , was set at 5 kV to avoid penetration of the beam into the Si substrate. The penetration depth of the electron beam is estimated to be shorter than 300 nm, which is the thickness of the BaSi<sub>2</sub> layers, when  $V_{ac}$  is 5 kV, with the density of BaSi<sub>2</sub> being 5.14 g/cm<sup>3</sup>.

### 3. Results and discussion

Figure 1(a) shows RHEED patterns of MBE-grown BaSi<sub>2</sub> observed along the Si [1-10] azimuth. Sharp streaky patterns of BaSi<sub>2</sub> can be seen. Figure 1(b) shows the  $\theta$ -2 $\theta$  XRD patterns from the sample. Diffraction peaks can be seen only from (100)-oriented BaSi<sub>2</sub> planes, such as the (200), (400) and (600) planes. These results indicate that highly a-axis-oriented BaSi<sub>2</sub> epitaxial films were grown.

Figure 2(a) shows a bright-field (BF) plan-view TEM image of the BaSi<sub>2</sub>. The incident electron beam direction was almost parallel to the BaSi<sub>2</sub> [100] zone axis, but was slightly tilted for the GBs to be seen clearly. Because GBs are parallel to the surface normal, their contrast vanishes in the exact [100] zone axis. The BaSi<sub>2</sub> grain size is approximately 0.1-0.3 µm. We should also note here that approximately 120° sharp GBs are present, and these GBs tend to align along specific directions. Figure 2(b) presents the SAED pattern obtained from the area including several BaSi<sub>2</sub> grains in the [100] zone axis. Considering that the GBs are caused by three different a-axis-oriented BaSi2 epitaxial variants rotated from each other by 120° with respect to the surface normal [14], the (002), (011), and (020) spots can be grouped into three, shown in red, green, and blue colors in Fig. 2(b). Considering the green and blue epitaxial variants, for example, the green (011) plane is parallel to the blue (002) plane. Thus, it can be stated that the grain boundary indicated by the white dotted line in Fig. 2(a) is composed of the green (011) plane and/or blue (002) plane. It is difficult to distinguish the green (011) plane from the blue (002) plane in the SAED pattern because their lattice spacing, d, is almost the same, that is,  $d_{(011)}=0.586$  nm, and  $d_{(002)}=0.579$  nm, respectively.

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Figure 3(a) shows SAED patterns obtained from single grain regions under two-beam diffraction conditions. The diffraction vectors **g** were set to be <004> for the three epitaxial variants shown by blue, red and green in Fig. 2(b). Under these conditions, the

diffraction spot corresponding to the (004) plane becomes bright, as seen in Fig. 3(b), while other spots denoted by (00n) ( $n=\pm 1,\pm 2,\pm 3,...$ ) can also be seen. These facts can help to distinguish (002) plane from (011) plane.

Figures 4(a)-4(c) show dark-field (DF) plan-view TEM images using <004> plane reflections observed at the same sample region. The diffraction conditions of these DF images are the same as those in Fig 3(a). Under these conditions, BaSi<sub>2</sub> grains satisfying Bragg's condition of diffraction, indicated by the blue-, red-, or green-colored domain, are supposed to be bright in these images; in other words, one of the three BaSi<sub>2</sub> epitaxial variants becomes bright in each figure. It should be noted that the superposition of bright regions in Figs. 4(a)-4(c) covers the whole surface of BaSi<sub>2</sub>. In Figs. 4(a)-4(c), it can be seen that the GBs are parallel to the dashed lines in the blue-, red-, and green-colored BaSi<sub>2</sub> variants, respectively. On the basis of this discussion, we conclude that the GBs are formed mostly from BaSi<sub>2</sub> {011} planes. Further discussion is mandatory to clarify why BaSi<sub>2</sub> {011} planes are likely to form GBs.

Figure 5(a) shows the current-voltage (*I-V*) characteristics of the Al/*n*-BaSi<sub>2</sub> Schottky diode measured at RT. The bias voltage was applied to the front Al contact with respect to the sputtered Al back contact. Rectifying properties can be clearly observed. More current flows when a positive bias is applied to the Al wire with respect to the back contact. These results indicate that the Al/*n*-BaSi<sub>2</sub> junction forms a Schottky diode.

Figures 6(a)(b) and 6(c)(d) show secondary-electron (SE) and EBIC images around the Al contact, respectively, with  $V_{\rm ac} = 5$  kV. In the EBIC method, carriers generated within the diffusion length in the *n*-type BaSi<sub>2</sub> are collected by the electric field under the Al contact and sensed as a current in the external circuit. In Figs. 6(c)(d), the brighter regions show higher collection of electron-beam-induced carriers in the BaSi<sub>2</sub>. We cannot see defect-related black lines. Figure 7 shows the EBIC line-scan data along dotted line AA' in Fig. 6(c). The EBIC profile shows an exponential dependence of the distance from the Al contact. In this work, the diffusion length of minority carriers was roughly estimated to be approximately 10 µm, assuming that the EBIC profile varies as  $\exp(-x/L)$ , where x is the distance from the Al edge (point A) along the dotted line, and L is the diffusion length of holes for BaSi<sub>2</sub>. The obtained minority-carrier diffusion length is much larger than the grain size of the BaSi<sub>2</sub>, implying that the GBs do not work as defect centers for minority carriers in n-BaSi<sub>2</sub>. The contribution of carriers generated within the *n*-Si substrate to the measured EBIC signals can be excluded, because the simulated penetration depth of the electron beam is shorter than 300 nm, the thickness of the BaSi<sub>2</sub> layers, when  $V_{\rm ac}$  is 5 kV. Thus, it is reasonable to think that the number of carriers generated within the Si substrate was negligibly small compared to those generated in the BaSi<sub>2</sub> layers. To confirm the GBs character, an EBIC system with spatial resolutions less than 0.1 µm may be necessary. We should also note here that the obtained minority-carrier diffusion length is roughly 30 times larger than  $1/\alpha$  (=0.3 µm) at 1.5 eV,

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suggesting that this value is large enough for solar cell applications.

# 4. Conclusions

We investigated the crystalline quality and GBs in a-axis-oriented BaSi $_2$  epitaxial films grown on Si(111) substrates by MBE using RHEED, XRD, and TEM. The grain size in the BaSi $_2$  films was found to be approximately 0.1-0.3  $\mu$ m. Detailed investigation of BF and DF TEM images and SAED patterns showed that the GBs in the BaSi $_2$  epitaxial layers consist mostly of BaSi $_2$  {011} planes. The EBIC techniques revealed that the diffusion length of minority carriers was estimated to be approximately 10  $\mu$ m, much larger than the grain size of the BaSi $_2$ .

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Fig.1 (a) RHEED patterns of MBE-grown BaSi<sub>2</sub> observed along the Si[1-10] azimuth (b)  $\theta$ -2 $\theta$ 212213 XRD pattern. 214Fig.2 (a) Plan-view BF TEM image near the [100] zone axis of BaSi<sub>2</sub>, and (b) SAED pattern 215 216 (crystallographic orientation) obtained from the area including several BaSi2 grains in the exact [100] zone axis. 217218 Fig. 3 (a) SAED patterns obtained from single grain regions under two-beam diffraction 219 220 conditions. The diffraction vectors **g** were set to three different <004> directions. (b) Enlarged SAED pattern. 221 222 Fig.4(a)-(c) DF TEM images under two-beam diffraction conditions. The diffraction vector **g** 223 was set to be <004> for each epitaxial variant. The schematics of three epitaxial variants of 224BaSi<sub>2</sub> are shown. The colored domains look bright in each DF TEM image. The dashed lines 225 226 correspond to {011} planes. 227 228 Fig. 5 *I-V* characteristics of the Al/n-BaSi<sub>2</sub> Schottky diode at RT. 229 230 Fig. 6 (a)(b) SE and (b)(d) EBIC images around the Al contact.

- Fig. 7 Experimental and simulated (solid line) EBIC line-scan profiles along the dotted line
- from points A to A' in Fig. 6(c).

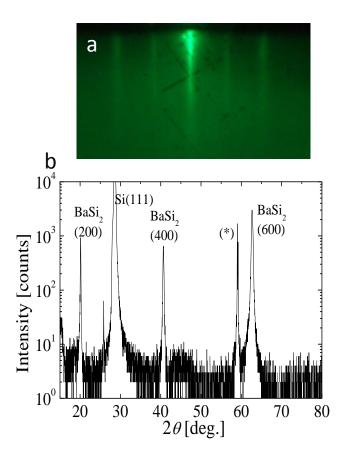


Fig. 1

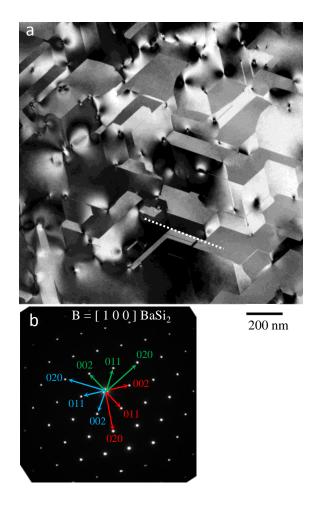


Fig. 2

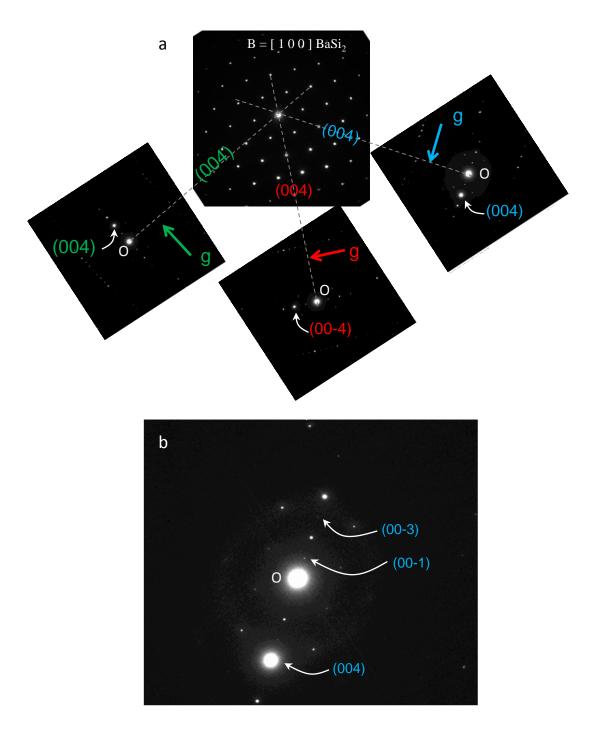


Fig. 3

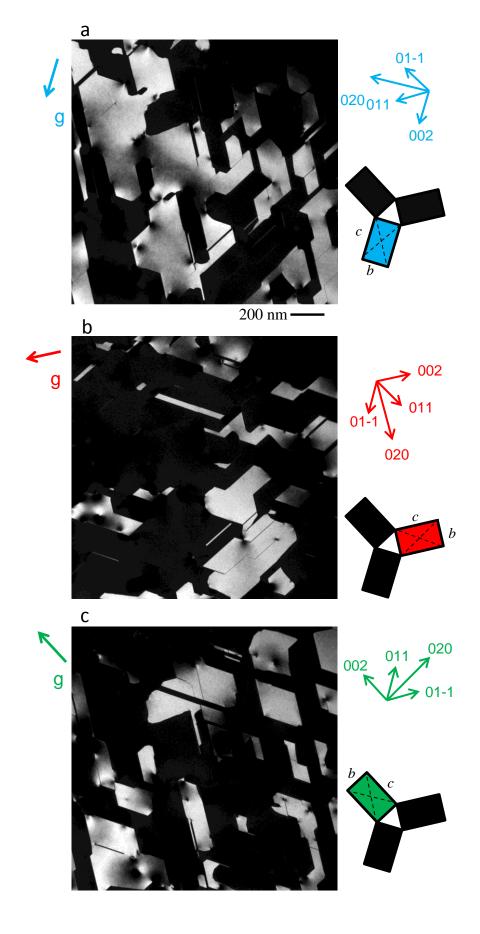


Fig. 4

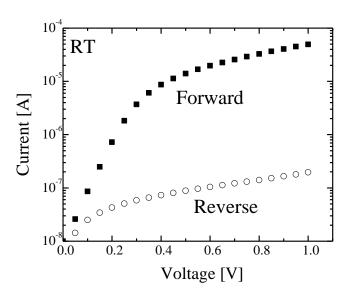


Fig. 5

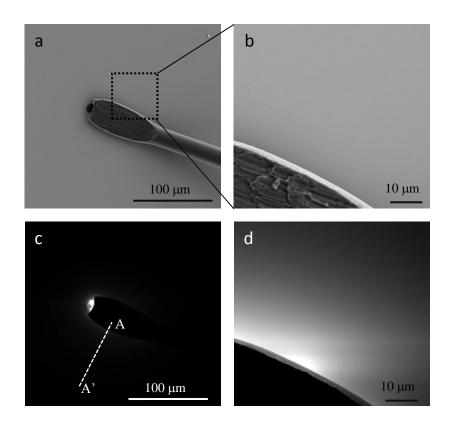


Fig. 6

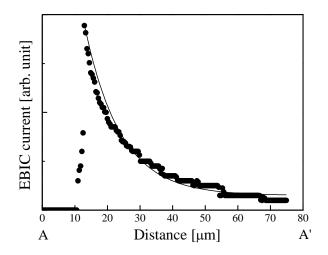


Fig. 7